



DT07 Rec'd PCT/PTO 08 FEB 2005

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

D. SAUTER et al.

Attorney Dkt. No.: 103196-00006

Serial No.: 10/500,918

Examiner: Not Assigned

Filed: July 8, 2004

For: VALUABLE DOCUMENT OR SECURITY DOCUMENT COMPRISING A SWITCH

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date: February 8, 2005

Sir:

Pursuant to 37 CFR §1.56, the attention of the Patent and Trademark Office is hereby directed to the information item(s) listed on the attached PTO-1449. Unless otherwise indicated herein, one copy of each item(s) is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the item(s) be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- 1. This Information Disclosure Statement is being filed (a) within three months of the U.S. filing date, OR (b) before the mailing date of a first Office Action on the merits in the present application, OR (c) accompanies a Request for Continued Examination. No certification or fee is required.
- 2. This Information Disclosure Statement is being filed more than three months after the U.S. filing date AND after the mailing date of the first Office Action on the merits, but before the mailing date of a Final Rejection or Notice of Allowance.
- a. I hereby certify that each item of information contained in this Information Disclosure Statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement. 37 CFR §1.97(e)(1).
- b. I hereby certify that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 CFR §1.97(e)(2).

- c. A check in the amount of \$180.00 in payment of the fee under 37 CFR §1.17(p). Please charge any fee deficiency or credit any overpayment to Deposit Account No. 01-2300 as needed to ensure consideration of the disclosed information.
- 3. This Information Disclosure Statement is being filed more than three months after the U.S. filing date and after the mailing date of a Final Rejection or Notice of Allowance, but before payment of the Issue Fee. Applicant(s) hereby petition(s) that the Information Disclosure Statement be considered. Attached is our check in the amount of \$180.00 in payment of the petition fee under 37 CFR §1.17(i)(1). Please charge any fee deficiency or credit any overpayment to Deposit Account No. 01-2300 as needed to ensure consideration of the disclosed information.
- a. I hereby certify that each item of information contained in this Information Disclosure Statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement. 37 CFR §1.97(e)(1).
- b. I hereby certify that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 CFR §1.97(e)(2).
- 4. The references were cited in a counterpart foreign application. An English language version of the foreign search report is attached for the Examiner's information.
- 4. German reference DE 37 288 was cited on the PTO-1449 incorrectly. This is an internal number. The reference has been cited again with the correct reference number DE 69 00 274 U.

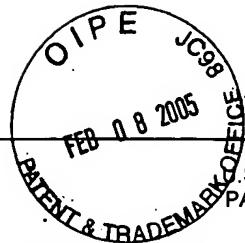
Respectfully submitted,



George E. Oram, Jr.
Registration No. 27,931

Customer No. 004372
AREN'T FOX PLLC
1050 Connecticut Avenue, N.W.,
Suite 400
Washington, D.C. 20036-5339
Tel: (202) 857-6000
Fax: (202) 638-4810

GEO/bgk



Sheet 1 of 1

FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

LIST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

ATTY. DOCKET NO. 103196-00006	SERIAL NO. 10/500,918
APPLICANT	
D. SAUTER et al.	
FILING DATE July 8, 2004	GROUP

U.S. PATENT DOCUMENTS

EXAMINER'S INITIALS		DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	AA	4,763,927	8/16/88	Schneider			
	AB	2002/114931 A1	8/22/02	Beghelli et al.			

FOREIGN PATENT DOCUMENTS

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION YES NO PART.
	AC	EP 1 134 694 A	9/19/01	Europe			X
	AD	WO 00/07151A	2/10/00	WIPO			X
	AE	DE 695 09 783 T2	4/25/96	Germany			X
	AF	DE 198 18 710 A1	10/28/99	Germany			X
	AG	DE 42 20 762 A1	1/7/93	Germany			X
	AH	DE 42 22 730 A1	1/21/93	Germany			X
	AI	DE 69 00 274 UI	8/27/70	Germany			X
	AJ	DE 197 16 343 A1	10/22/98	Germany			X

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

AK	"Plastic Solar Cells", Advanced Function Material, 2001, No. 1, February, pgs. 15-26
AL	"Will Polymer Electronics Change the Electronics Industry?", Polytronic, Apr. 2001, Conference Proceedings, pgs. 1-8
AM	"Euro Bank Notes To Embed RFID Chips By 2005", EETIMES, Dec. 19, 2001, http://www.eetimes.com/printable Article?doc id=OEG20011219S0016 (internet pg. investigated on March 4, 2004)
AN	"Polytronic: Chips von der Rolle", Fraunhofer Magazine, Apr. 2001, pgs. 8-12, www.fraunhofer.de/german/publications/df/df/2001/mag4-2001.pdf (internet pg. investigated on March 4, 2004)
AO	"Faltlautsprecher für die Hosentasche", News dated April 27, 2001, http://www.heise/de/newsticker/meldung/print/17400 (internet pg.)

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.